INTEGRATED CIRCUITS

DATA SHEET



74ALS175Quad D flip—flop

Product specification IC05 Data Handbook

1991 Feb 08





Quad D flip-flop

74ALS175

FEATURES

- Four edge-triggered D flip-flops
- Buffered common clock
- Buffered asynchronous master reset
- True and complementary outputs

DESCRIPTION

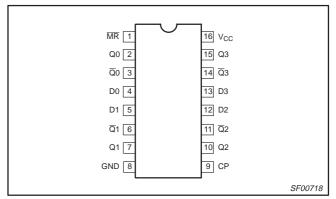
The 74ALS175 is a quad, edge-triggered D-type flip-flops with individual D inputs and both Q and \overline{Q} outputs. The common buffered clock (CP) and master reset (\overline{MR}) inputs load and reset (clear) all flip-flops simultaneously.

The register is fully edge-triggered. The state of each D input, one setup time before the Low-to-High clock transition is transferred to the corresponding flip-flop's Q output.

All Q outputs will be forced Low independent of clock or data inputs by a Low voltage level on the $\overline{\text{MR}}$ input. The device is useful for applications where both true and complement outputs are required, and the clock and master reset are common to all storage elements.

TYPE	TYPICAL f _{MAX}	TYPICAL SUPPLY CURRENT (TOTAL)
74ALS175	70MHz	7mA

PIN CONFIGURATION



ORDERING INFORMATION

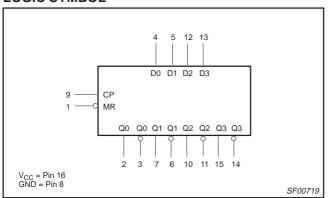
3. 32	ORDER CODE		
DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V ±10%, T_{amb} = 0°C to +70°C	DRAWING NUMBER	
16-pin plastic DIP	74ALS175N	SOT38-4	
16-pin plastic SO	74ALS175D	SOT109-1	

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

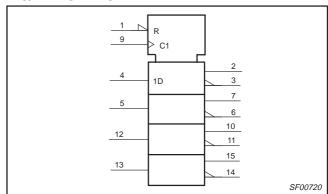
PINS	DESCRIPTION	74ALS (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
D0 – D3	Data inputs	1.0/1.0	20μA/0.1mA
СР	Clock Pulse input (active rising edge)	1.0/1.0	20μA/0.1mA
MR	Master Reset input (active-Low)	1.0/1.0	20μA/0.1mA
Q0 – Q3	True outputs	20/80	0.4mA/8mA
$\overline{Q}0 - \overline{Q}3$	Complementary outputs	20/80	0.4mA/8mA

NOTE: One (1.0) ALS unit load is defined as: 20μA in the High state and 0.1mA in the Low state.

LOGIC SYMBOL



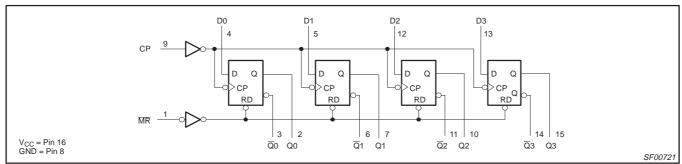
IEC/IEEE SYMBOL



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LOGIC DIAGRAM



FUNCTION TABLE

	INPUTS		ОИТІ	PUTS	OPERATING
MR	СР	D	Q _n	Qn	MODE
L	Х	Х	L	Н	Reset (clear)
Н	1	h	Н	Lag 30	Load "1"
Н	1	I	L	3HT	Load "0"

NOTES:

H = High-voltage level

h = High state must be present one setup time before the Low-to-High clock transition

_ = Low-voltage level

= Low state must be present one setup time before the Low-to-High clock transition

X = Don't care

= Low-to-High clock transition

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _{IN}	Input voltage	-0.5 to +7.0	V
I _{IN}	Input current	-30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	−0.5 to V _{CC}	V
lout	Current applied to output in Low output state	16	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature range	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		UNIT		
STWIBUL	PARAMETER	MIN	NOM	MAX	UNII
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V
V _{IL}	Low-level input voltage			0.8	V
I _{IK}	Input clamp current			-18	mA
I _{OH}	High-level output current			-0.4	mA
I _{OL}	Low-level output current			8	mA
T _{amb}	Operating free-air temperature range	0		+70	°C

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DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

CVMDOL	PARAMETER	TECT COMPIT	TEST CONDITIONS ¹				UNIT
SYMBOL	PARAMETER	TEST CONDIT	MIN	TYP ²	MAX	UNIT	
V _{OH}	High-level output voltage	V _{CC} ±10%, V _{IL} = MAX, V _{IH}	= MIN, I _{OH} = MAX	V _{CC} -2			V
\/	Low lovel output voltage	V _{CC} = MIN, V _{IL} = MAX,	$I_{OL} = 4mA$		0.25	0.4	V
VOL	V _{OL} Low-level output voltage	V _{IH} = MIN		0.35	0.50	V	
V_{IK}	Input clamp voltage	$V_{CC} = MIN, I_I = I_{IK}$	$V_{CC} = MIN, I_I = I_{IK}$			-1.5	V
I _I	Input current at maximum input voltage	$V_{CC} = MAX, V_I = 7.0V$				100	μΑ
I _{IH}	High-level input current	$V_{CC} = MAX, V_I = 2.7V$				20	μΑ
I _{IL}	Low-level input current	$V_{CC} = MAX, V_I = 0.5V$				-0.1	mA
I _O	Output current ³	$V_{CC} = MAX, V_O = 2.25V$	-30		-112	mA	
I _{CC}	Supply current (total)	$V_{CC} = MAX$			7	14	mA

NOTES:

- 1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- 2. All typical values are at $V_{CC} = 5V$, $T_{amb} = 25$ °C.
- 3. The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

AC ELECTRICAL CHARACTERISTICS

			LIM	ITS	J I
SYMBOL	PARAMETER	TEST CONDITION	T _{amb} = 0°C V _{CC} = +5. C _L = 50pF,	0V ± 10%	UNIT
			MIN	MAX	
f _{MAX}	Maximum clock frequency	Waveform 1	60		MHz
t _{PLH} t _{PHL}	Propagation delay CP to Qn or CP to \(\overline{Q} \n \)	Waveform 1	3.0 5.0	13.0 16.0	ns
t _{PLH}	Propagation delay, MR to Qn	Waveform 2	3.0	13.0	ns
t _{PHL}	Propagation delay, \overline{MR} to \overline{Q} n	Waveform 2	8.0	18.0	ns

AC SETUP REQUIREMENTS

			LIM		
SYMBOL	PARAMETER	TEST CONDITION	T _{amb} = 0°0 V _{CC} = +5. C _L = 50pF,	UNIT	
			MIN	MAX	1
t _{su} (H) t _{su} (L)	Setup time, High or Low Dn to CP	Waveform 3	6.0 6.0		ns
t _h (H) t _h (L)	Hold time, High or Low Dn to CP	Waveform 3	0.0 0.0		ns
t _w (H) t _w (L)	CP pulse width, High or Low	Waveform 1	8.0 8.0		ns
t _w (L)	MR pulse width, Low	Waveform 2	6.0		ns
t _{REC}	Recovery time, MR to CP	Waveform 2	6.0		ns

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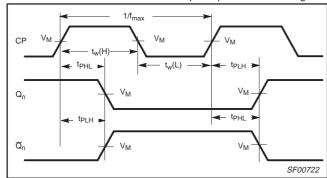
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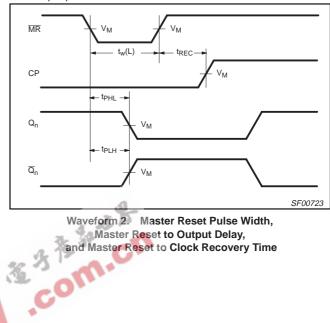
AC WAVEFORMS

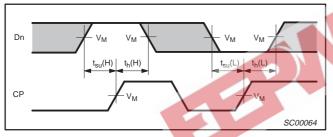
For all waveforms, $V_M = 1.3V$.

The shaded areas indicate when the input is permitted to change for predictable output performance.



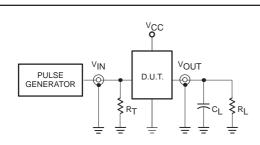
Propagation Delay for Clock Input to Output, Waveform 1. Clock Pulse Width, and Maximum Clock Frequency





Waveform 3. Data Setup and Hold Times

TEST CIRCUIT AND WAVEFORMS



Test Circuit for Totem-pole Outputs

AMP (V) 90% NEGATIVE ٧N ^{V}M PULSE 10% 10% 0.3V tTHL (tff) - tTLH (tr) tTHL (tf) AMP (V) 90% 90% POSITIVE 0.3V

DEFINITIONS:

R_L = Load resistor;

see AC electrical characteristics for value.

Load capacitance includes jig and probe capacitance; see AC electrical characteristics for value.

Termination resistance should be equal to Z_{OUT} of pulse generators.

Input Pulse Definition

INPUT PULSE REQUIREMENTS Family									
rainily	Amplitude	V_{M}	Rep.Rate	t _w	t _{TLH}	t _{THL}			
74ALS	3.5V	3.5V 1.3V 1MHz		500ns	2.0ns	2.0ns			

SC00005

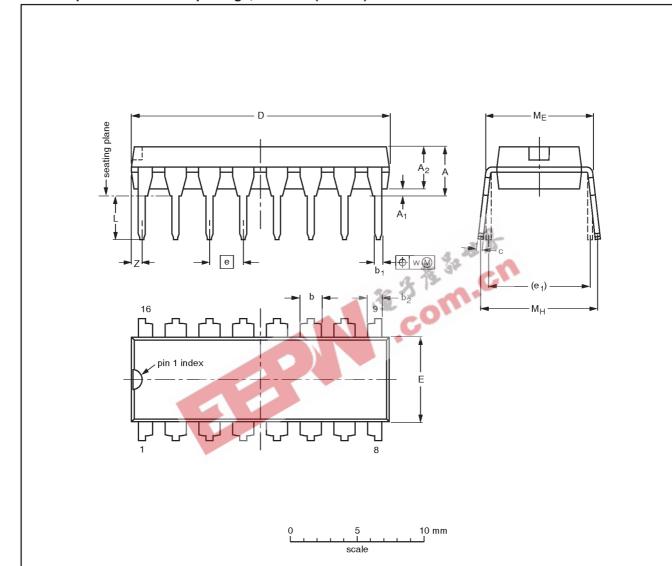
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DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	Мн	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT38-4					92-11-17 95-01-14

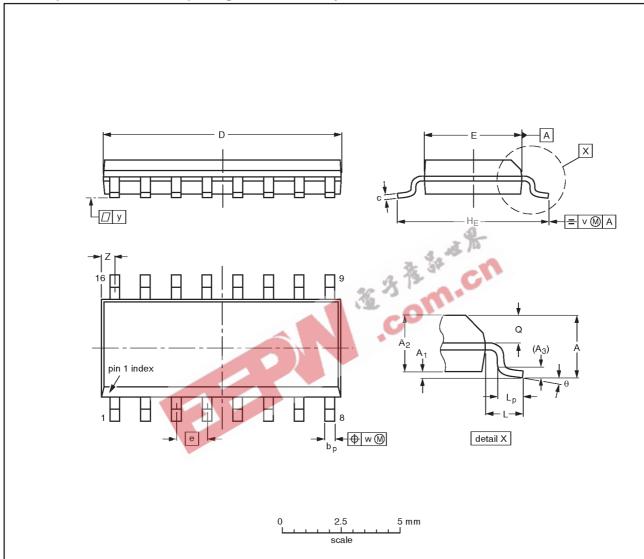
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SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	Α1	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.0098 0.0039		0.01	0.019 0.014	0.0098 0.0075	0.39 0.38	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1990E DATE	
SOT109-1	076E07\$	MS-012AC				91-08-13 95-01-23	

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		JEI IMITIONS
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